

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSIII<sup>5</sup>)

## 2SK1544

DC-DC Converter and Motor Drive Applications

Unit: mm

- Low drain-source ON resistance :  $R_{DS(ON)} = 0.15 \Omega$  (typ.)
- High forward transfer admittance :  $|Y_{fs}| = 21 S$  (typ.)
- Low leakage current :  $I_{DSS} = 300 \mu A$  (max) ( $V_{DS} = 500 V$ )
- Enhancement mode :  $V_{th} = 1.5 \sim 3.5 V$  ( $V_{DS} = 10 V$ ,  $I_D = 1 mA$ )

### Absolute Maximum Ratings ( $T_a = 25^\circ C$ )

Characteristics	Symbol	Rating	Unit
Drain-source voltage	$V_{DSS}$	500	V
Drain-gate voltage ( $R_{GS} = 20 k\Omega$ )	$V_{DGR}$	500	V
Gate-source voltage	$V_{GSS}$	$\pm 30$	V
Drain current	DC (Note 1)	$I_D$	A
	Pulse (Note 1)	$I_{DP}$	
Drain power dissipation ( $T_c = 25^\circ C$ )	$P_D$	200	W
Channel temperature	$T_{ch}$	150	$^\circ C$
Storage temperature range	$T_{stg}$	$-55 \sim 150$	$^\circ C$

JEDEC	—
JEITA	—
TOSHIBA	2-21F1B

Weight: 9.75 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

### Thermal Characteristics

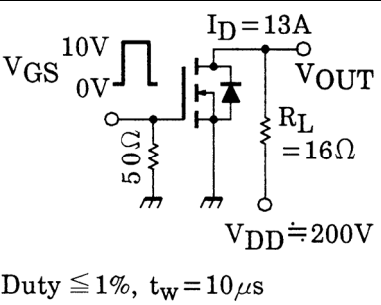
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th(ch-c)}$	0.625	$^\circ C / W$
Thermal resistance, channel to ambient	$R_{th(ch-a)}$	35.7	$^\circ C / W$

Note 1: Ensure that the channel temperature does not exceed  $150^\circ C$ .

This transistor is an electrostatic-sensitive device.

Please handle with caution.

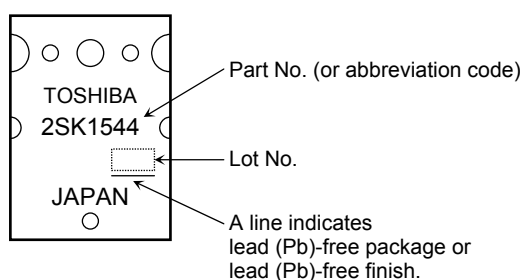
## Electrical Characteristics (Ta = 25°C)

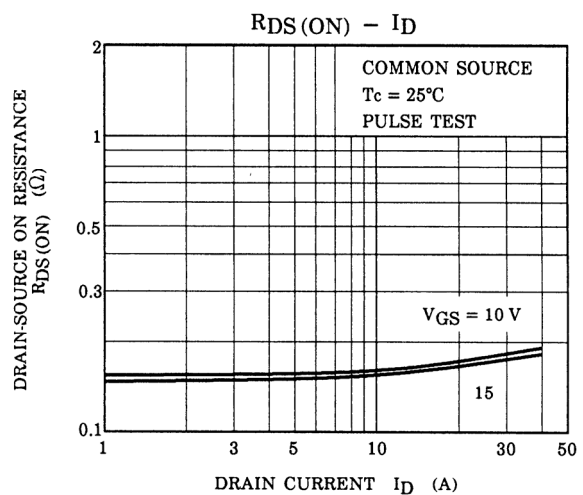
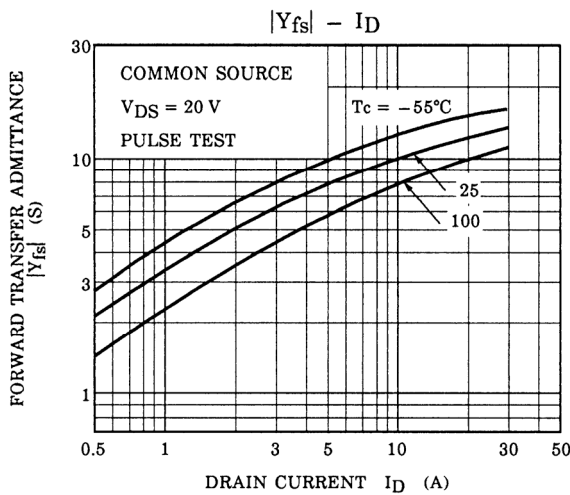
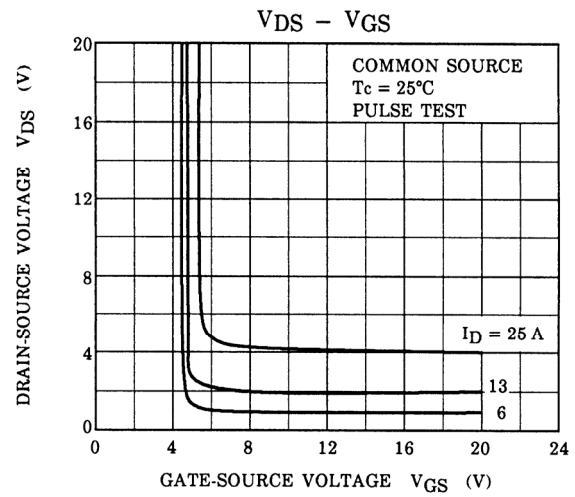
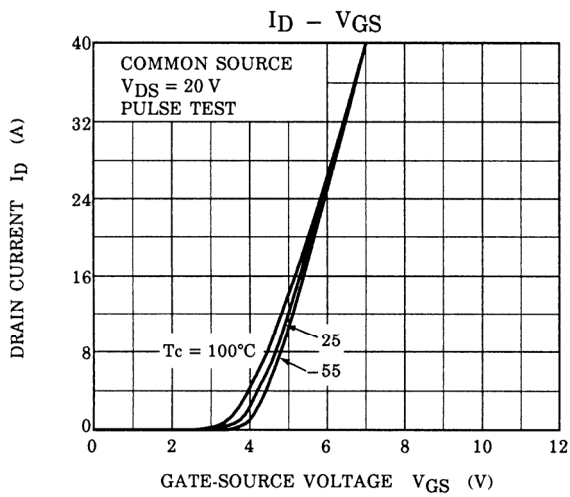
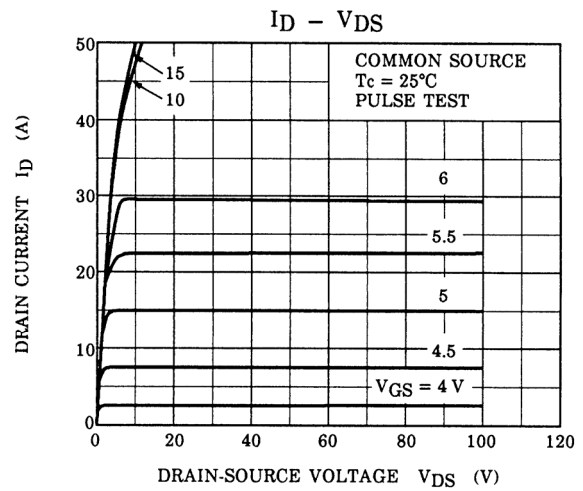
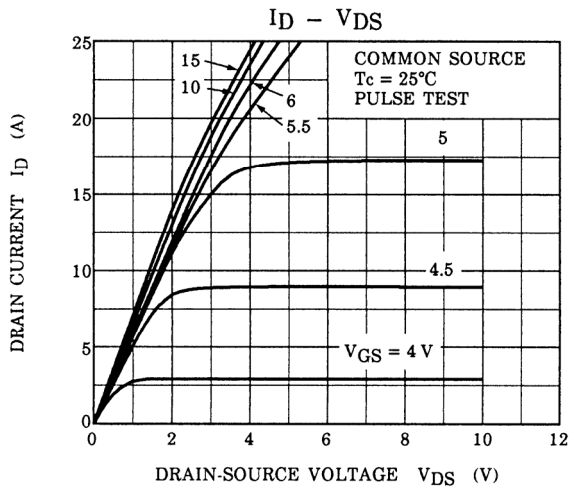
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	—	—	$\pm 100$	nA
Drain cut-off current		$I_{DSS}$	$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$	—	—	300	$\mu\text{A}$
Drain-source breakdown voltage		$V_{(BR) DSS}$	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	500	—	—	V
Gate threshold voltage		$V_{th}$	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	1.5	—	3.5	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = 10 \text{ V}, I_D = 13 \text{ A}$	—	0.15	0.20	$\Omega$
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = 10 \text{ V}, I_D = 13 \text{ A}$	10	21	—	S
Input capacitance		$C_{iss}$	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	—	3700	—	pF
Reverse transfer capacitance		$C_{rss}$		—	400	—	
Output capacitance		$C_{oss}$		—	920	—	
Switching time	Rise time	$t_r$		—	185	—	ns
	Turn-on time	$t_{on}$		—	240	—	
	Fall time	$t_f$		—	250	—	
	Turn-off time	$t_{off}$		—	590	—	
Total gate charge (Gate-source plus gate-drain)		$Q_g$	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 25 \text{ A}$	—	150	—	nC
Gate-source charge		$Q_{gs}$		—	70	—	
Gate-drain ("miller") charge		$Q_{gd}$		—	80	—	

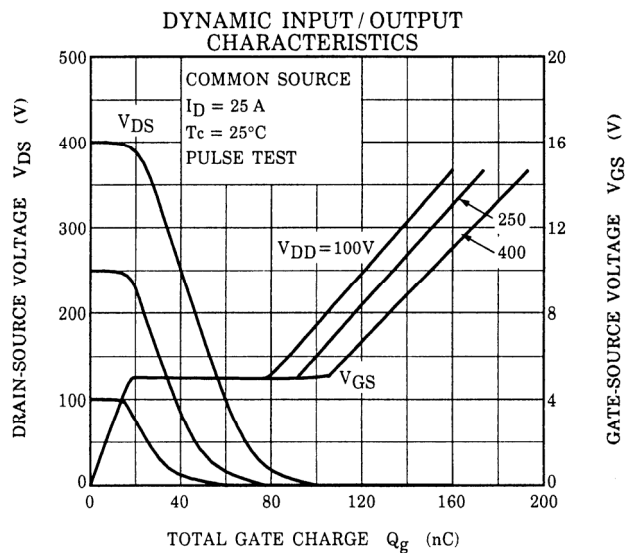
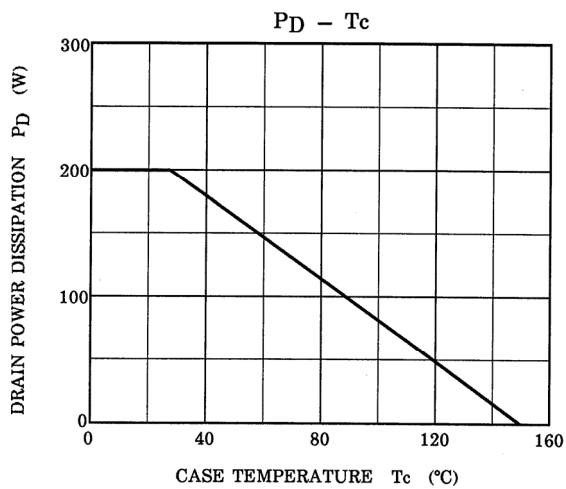
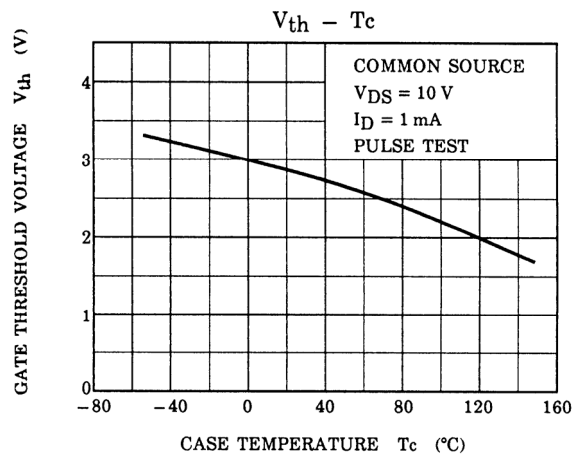
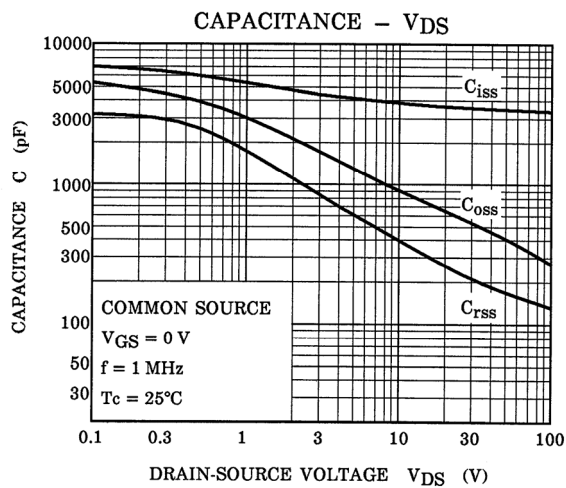
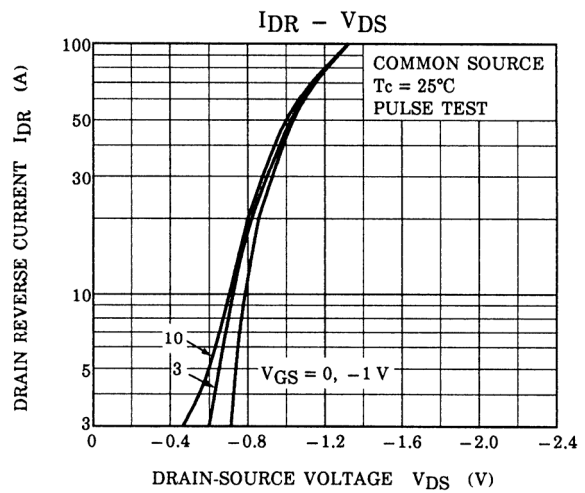
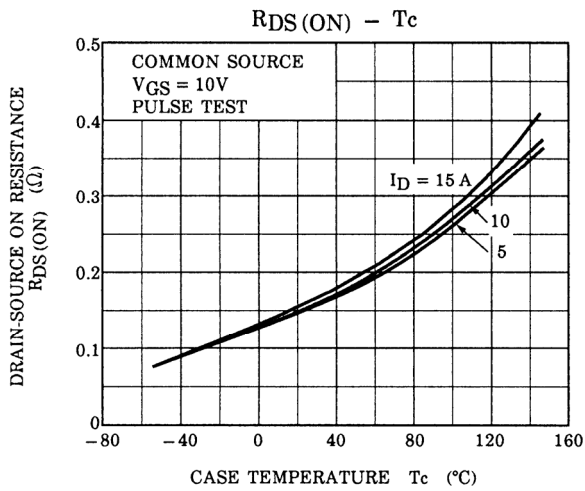
## Source-Drain Ratings and Characteristics (Ta = 25°C)

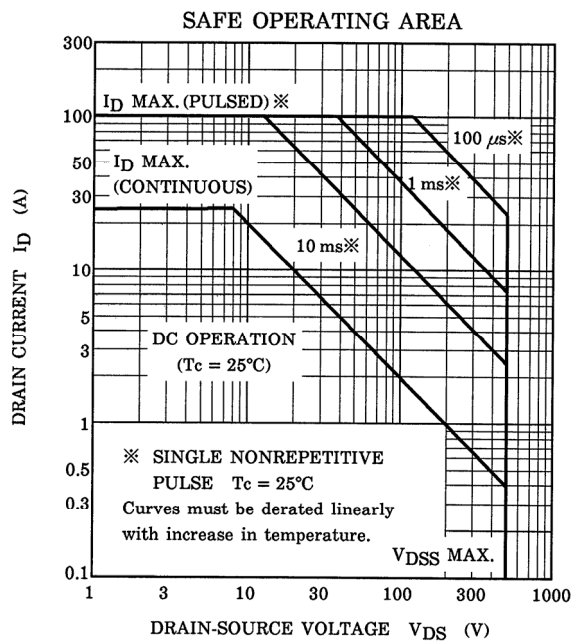
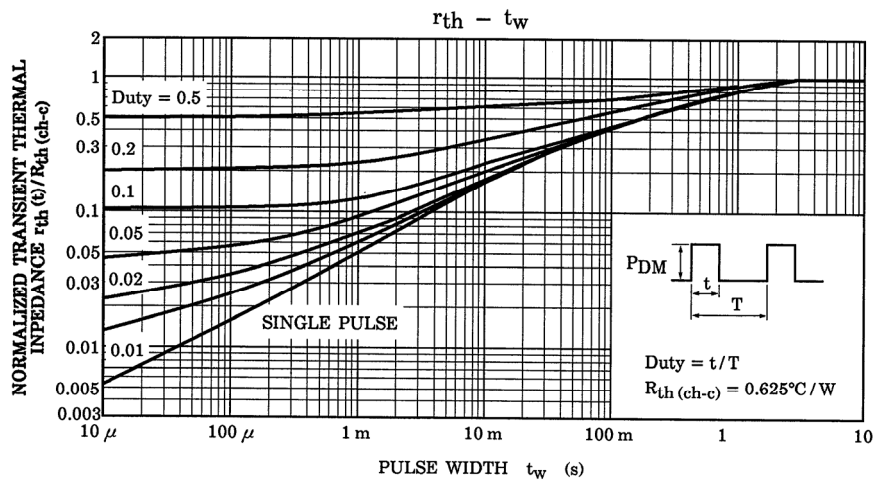
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	$I_{DR}$	—	—	—	25	A
Pulse drain reverse current (Note 1)	$I_{DRP}$	—	—	—	100	A
Forward voltage (diode)	$V_{DSF}$	$I_{DR} = 25 \text{ A}, V_{GS} = 0 \text{ V}$	—	—	-1.6	V
Reverse recovery time	$t_{rr}$	$I_{DR} = 25 \text{ A}, V_{GS} = 0 \text{ V}$ $di_{DR} / dt = 100 \text{ A} / \mu\text{s}$	—	780	—	ns
Reverse recovered charge	$Q_{rr}$		—	9.8	—	$\mu\text{C}$

## Marking









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